



UTT50P04

Power MOSFET

**-40V, -50A P-CHANNEL
POWER MOSFET**

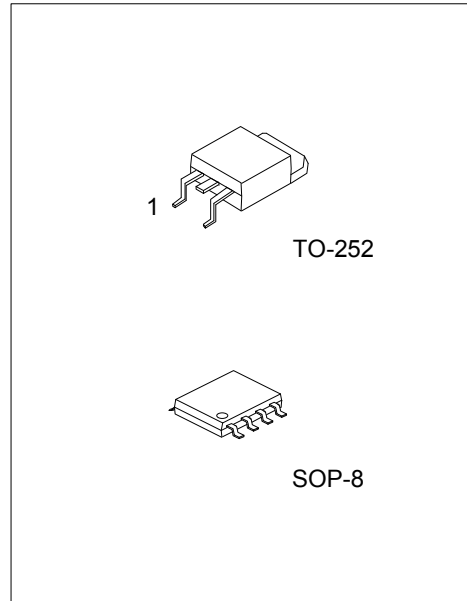
■ DESCRIPTION

The UTC **UTT50P04** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed and a minimum on-state resistance, and it can also withstand high energy in the avalanche.

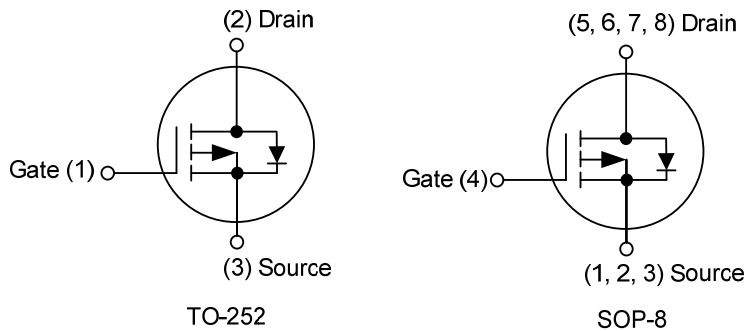
This UTC **UTT50P04** is suitable for motor drivers, high-side switch and 12V board net, etc.

■ FEATURES

- * $R_{DS(ON)} \leq 15 \text{ m}\Omega @ V_{GS}=-10V, I_D=-30A$
- * High Switching Speed



■ SYMBOL



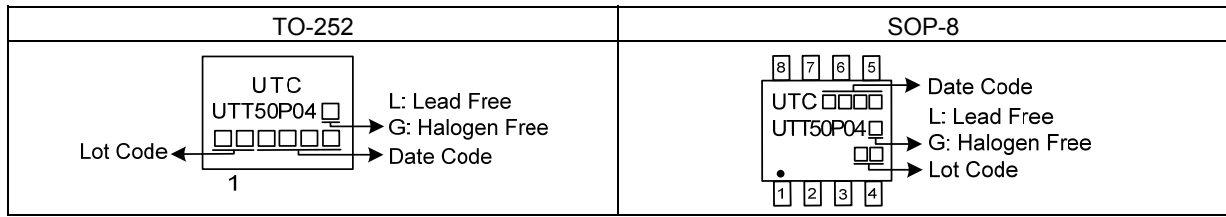
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UTT50P04L-TN3-R	UTT50P04G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UTT50P04L-S08-R	UTT50P04G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>UTT50P04G-TN3-R</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) R: Tape Reel</p> <p>(2) TN3: TO-252, S08: SOP-8</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	-40	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	-50 (Note 2)	A
	Pulsed	I_{DM}	-100	A
Continuous Source Current (Diode Conduction)		I_S	-50 (Note 2)	A
Avalanche Current		I_{AR}	-40	A
Avalanche Energy		E_{AS}	80	mJ
Power Dissipation	TO-252	P_D	50	W
	SOP-8		4.5	W
Junction Temperature		T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient (Note 1)	TO-252	θ_{JA}	110	$^\circ\text{C/W}$
	SOP-8		100	$^\circ\text{C/W}$
Junction to Case	TO-252	θ_{JC}	2.5	$^\circ\text{C/W}$
	SOP-8		27.8	$^\circ\text{C/W}$

Notes: 1. Surface Mounted on 1"x1" FR4 Board.

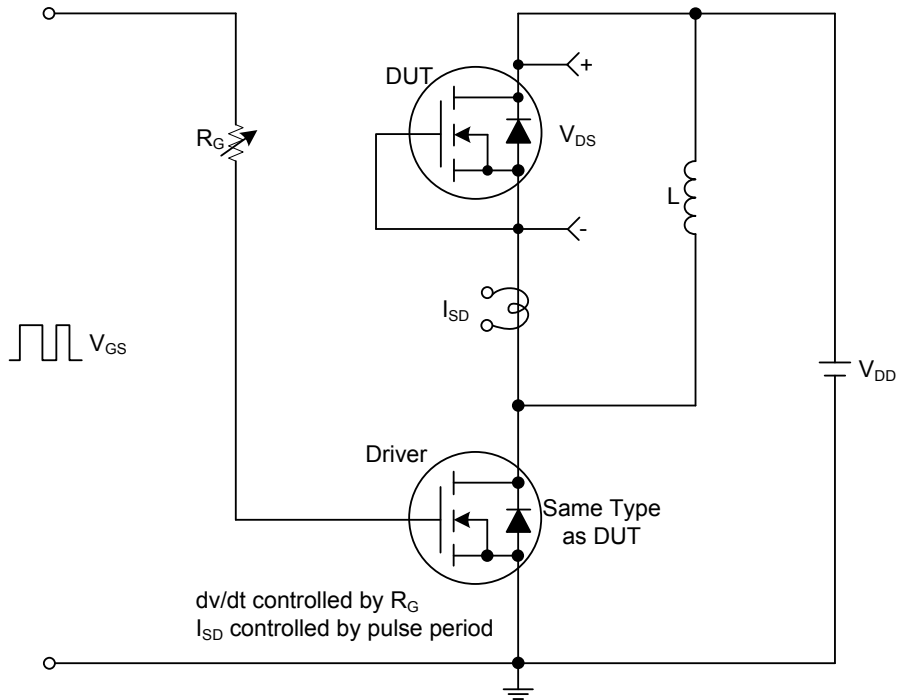
2. Calculated based on maximum allowable Junction Temperature. Package limitation current is 50A.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

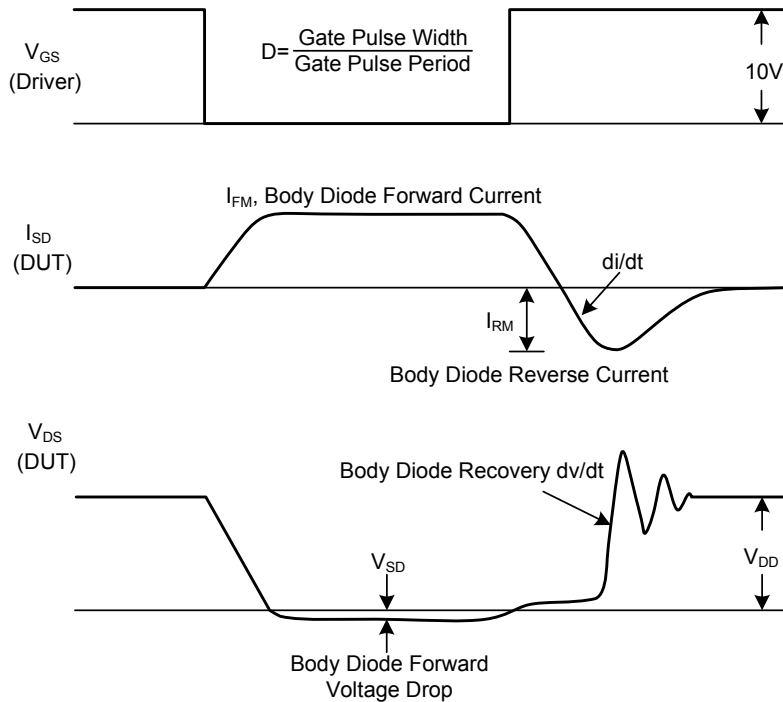
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =-250μA, V _{GS} =0V	-40			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-40V, V _{GS} =0V			-1	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V		+100	nA
	Reverse		V _{GS} =-20V, V _{DS} =0V		-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =-250μA	-1.0		-3.0	V
Static Drain-Source On-State Resistance (Note 1)	R _{DS(ON)}	V _{GS} =-10V, I _D =-30A			15	mΩ
		V _{GS} =-4.5V, I _D =-20A			25	mΩ
DYNAMIC PARAMETERS (Note 2)						
Input Capacitance	C _{ISS}	V _{DS} =-25V, V _{GS} =0V, f=1MHz		3140		pF
Output Capacitance	C _{OSS}			384		pF
Reverse Transfer Capacitance	C _{RSS}			289		pF
SWITCHING PARAMETERS (Note 2)						
Total Gate Charge (Note 3)	Q _G	V _{GS} =-5V, V _{DS} =-20V, I _D =-50A		32.8		nC
				62.6		nC
Gate to Source Charge (Note 3)	Q _{GS}	V _{GS} =-10V, V _{DS} =-20V, I _D =-50A		20.2		nC
Gate to Drain Charge (Note 3)	Q _{GD}			8.2		nC
Turn-ON Delay Time (Note 3)	t _{D(ON)}	V _{DD} =-20V, V _{GEN} =-10V, I _D ≈-50A, R _L =0.4 Ω, R _G =2.5Ω		15		ns
Rise Time (Note 3)	t _R			18		ns
Turn-OFF Delay Time (Note 3)	t _{D(OFF)}			60		ns
Fall-Time (Note 3)	t _F			47		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C=25°C)						
Maximum Body-Diode Pulsed Current	I _{SM}				-50	A
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _F =-50A, V _{GS} =0V			-1.5	V

- Notes: 1. Pulse test; pulse width≤300μs, duty cycle≤2%.
 2. Guaranteed by design, not subject to production testing.
 3. Independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



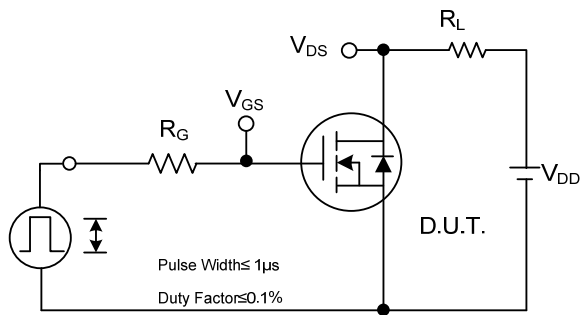
Peak Diode Recovery dv/dt Test Circuit



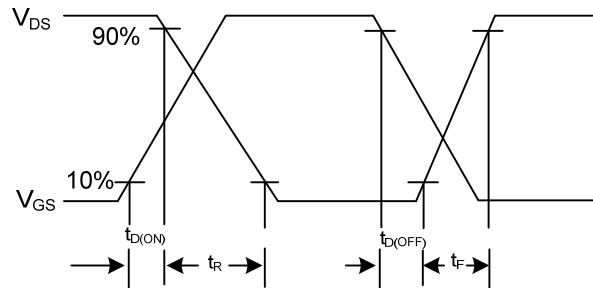
Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

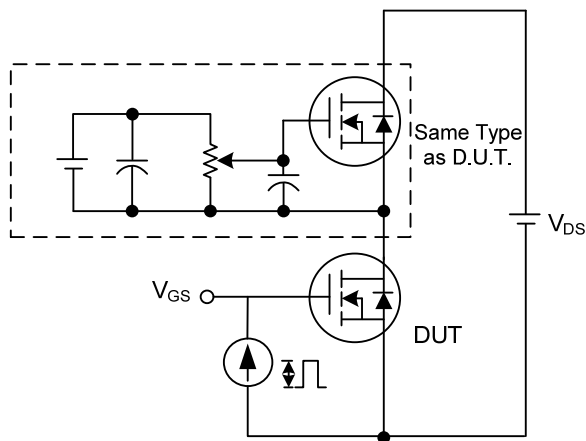
TEST CIRCUITS AND WAVEFORMS



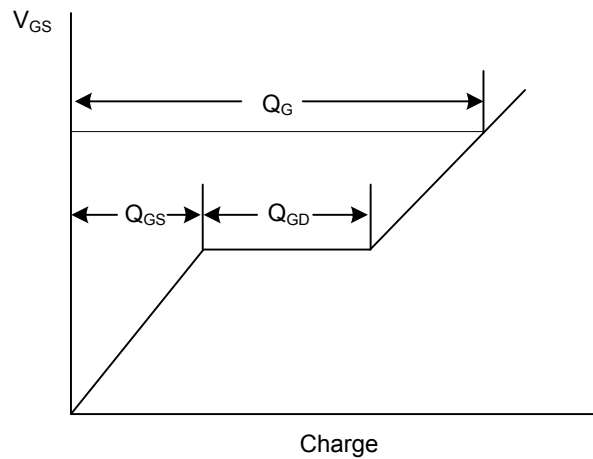
Switching Test Circuit



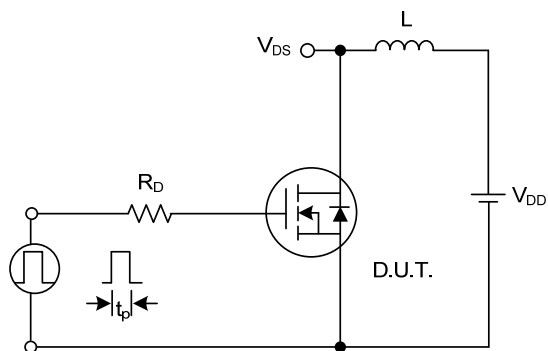
Switching Waveforms



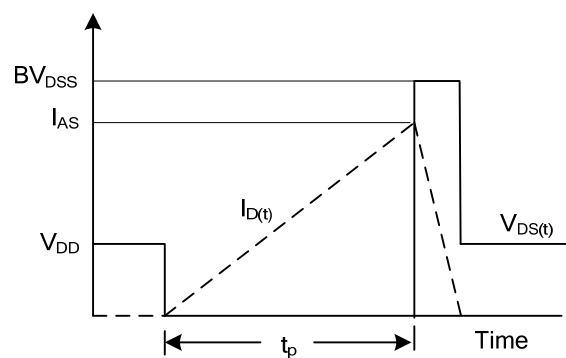
Gate Charge Test Circuit



Gate Charge Waveform

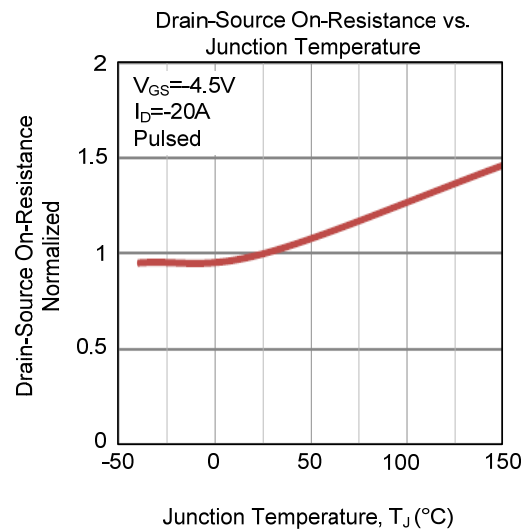
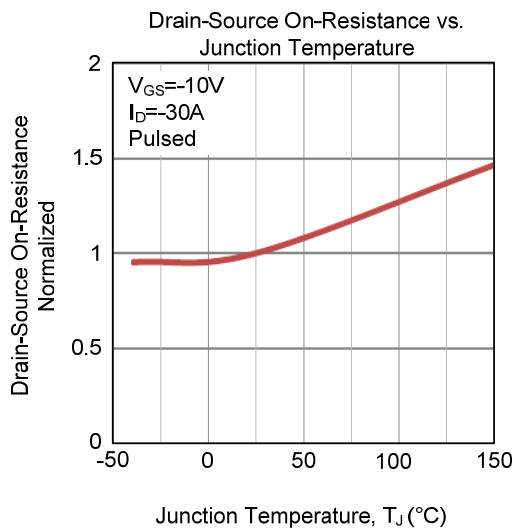
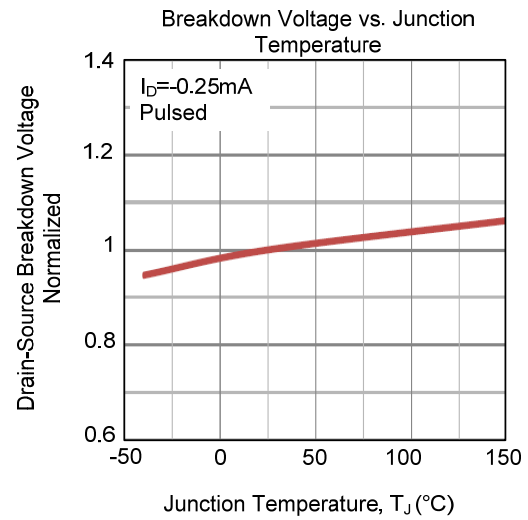
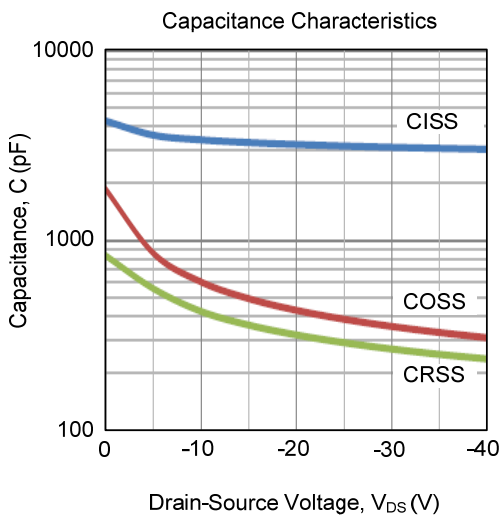
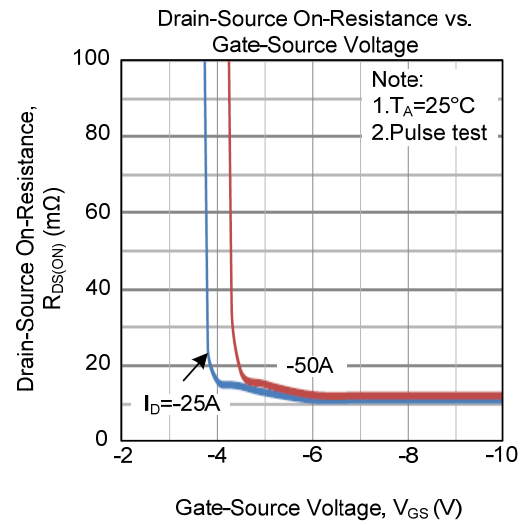
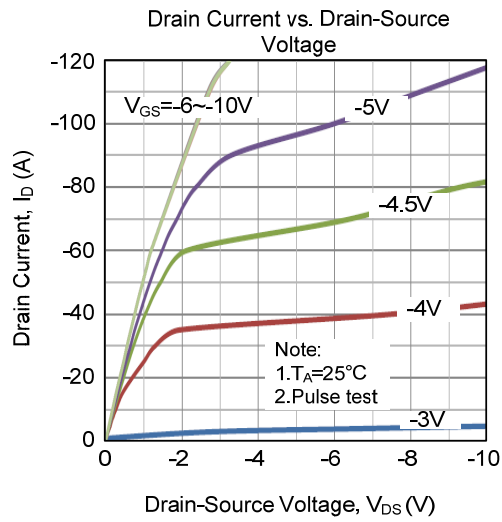


Unclamped Inductive Switching Test Circuit

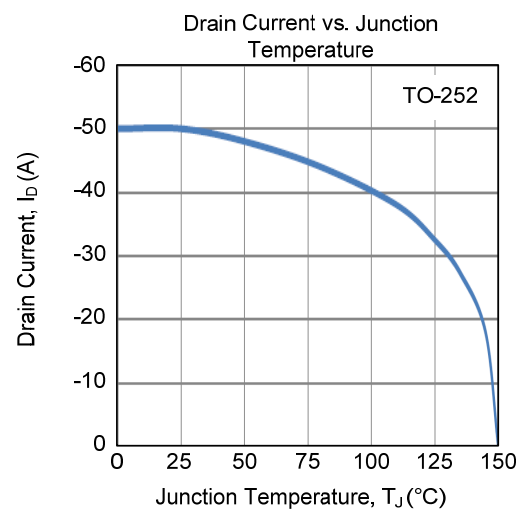
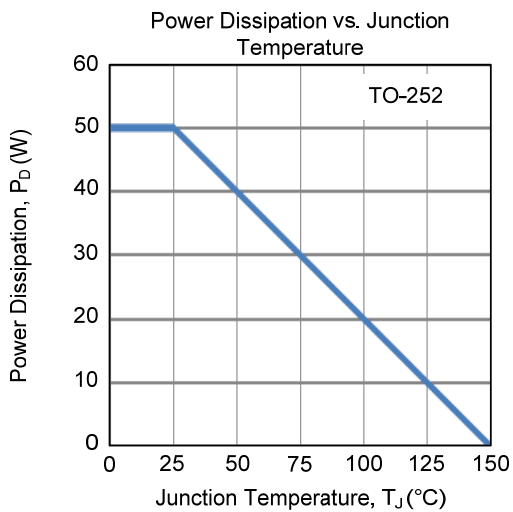
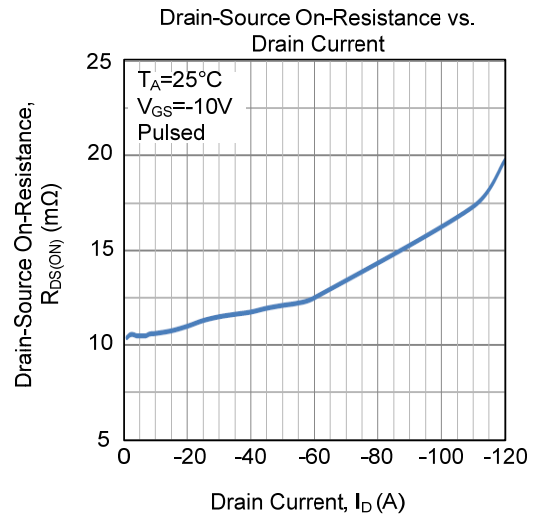
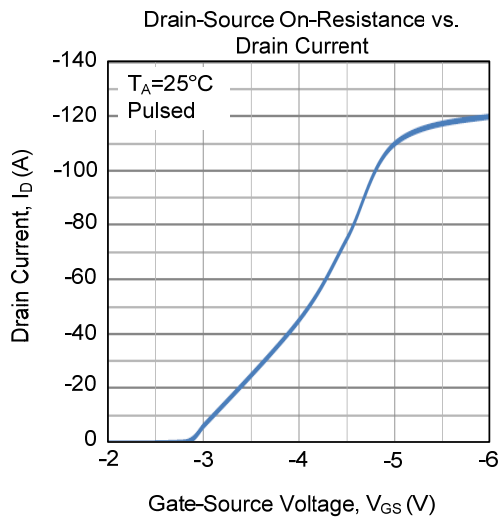
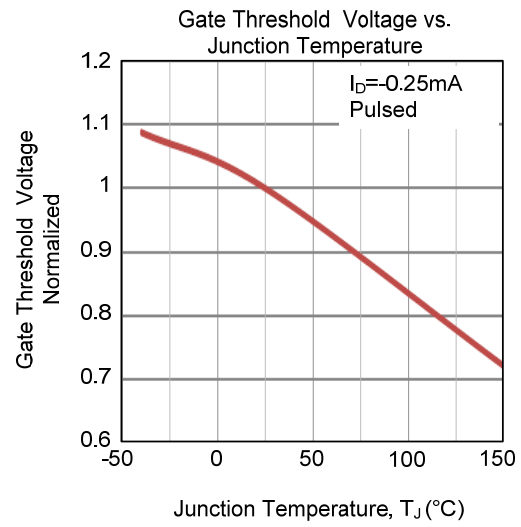
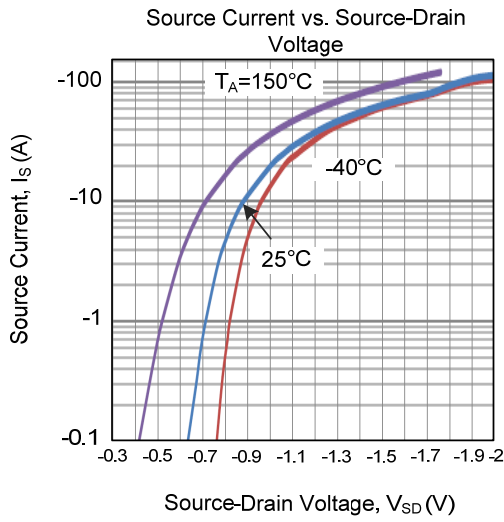


Unclamped Inductive Switching Waveforms

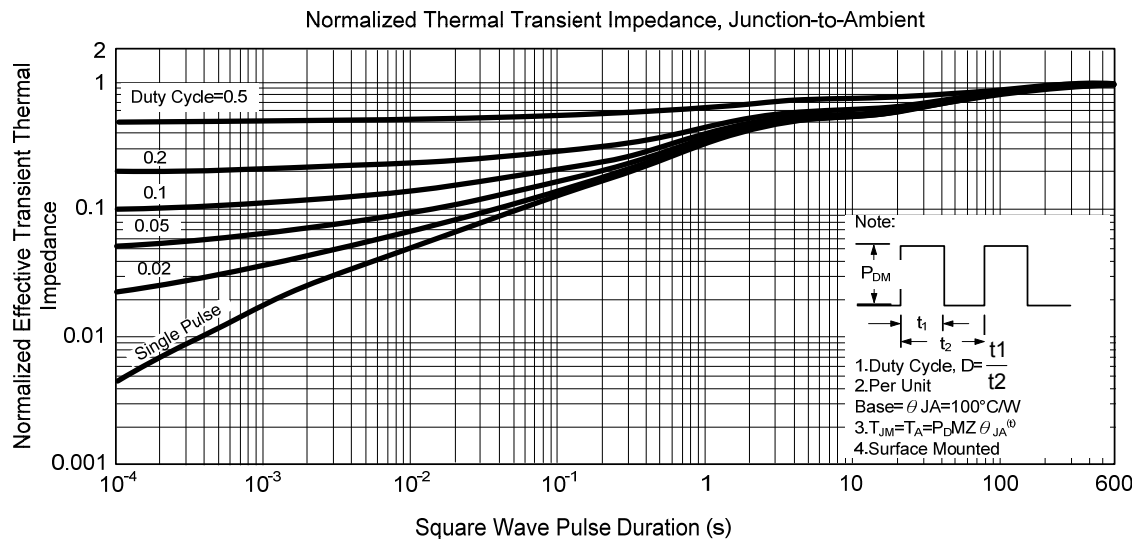
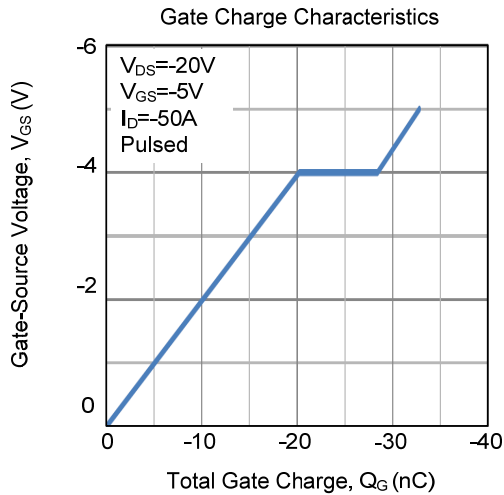
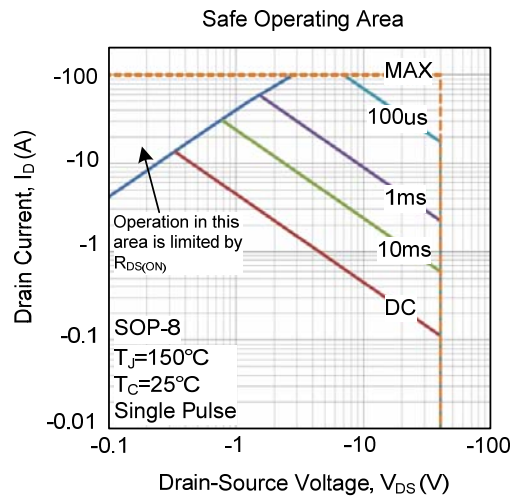
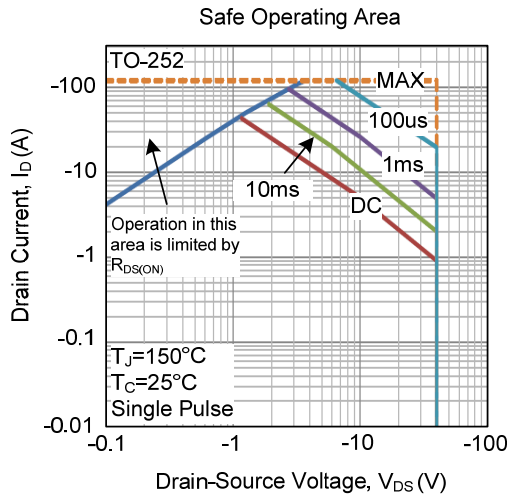
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Cont.)



TYPICAL CHARACTERISTICS (Cont.)



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